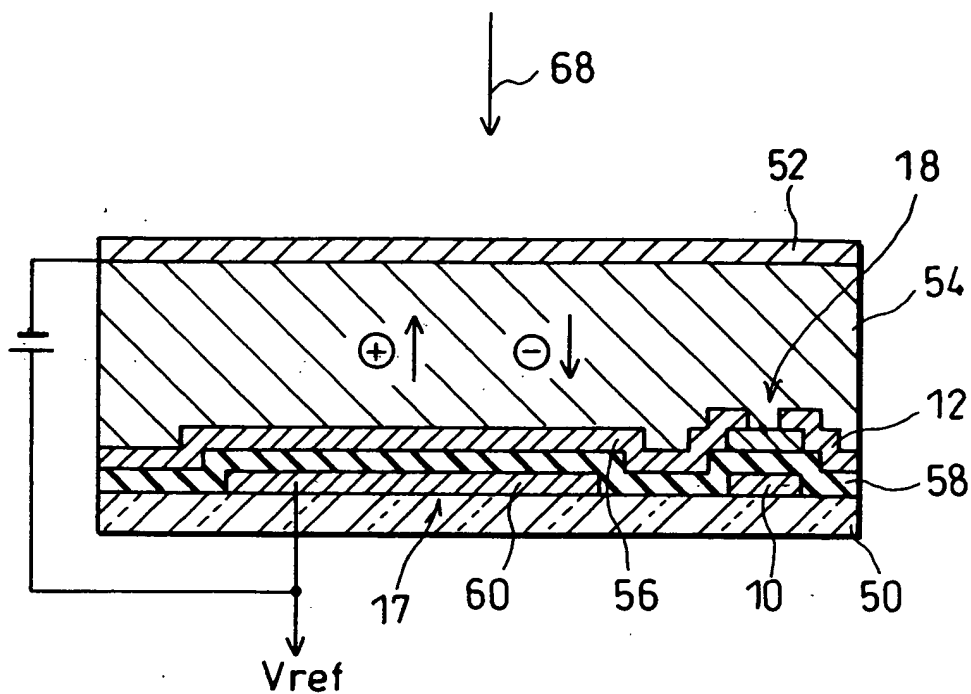
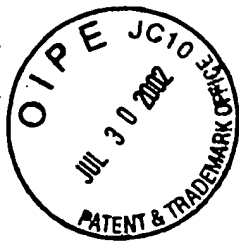


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FIG. 2

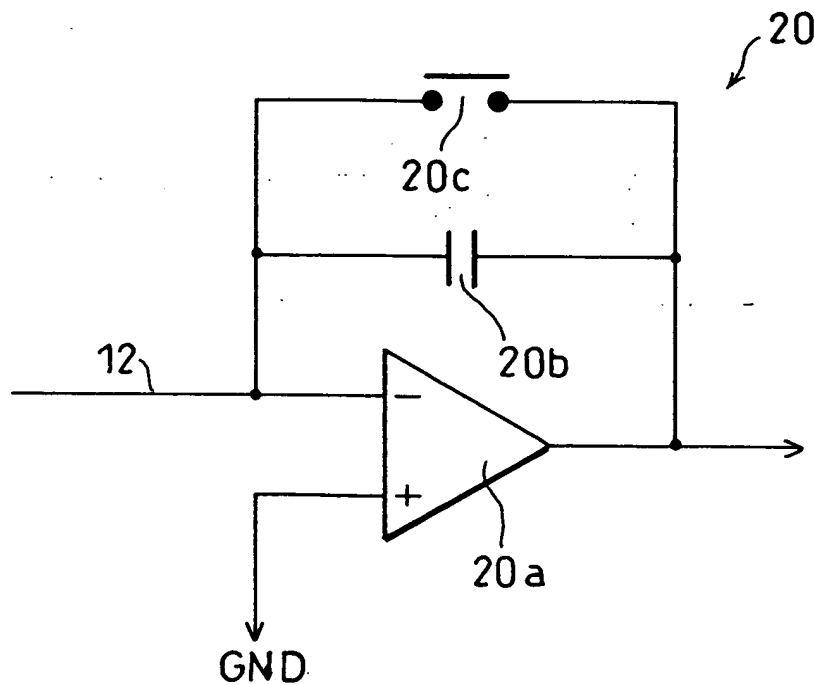


Prior Art

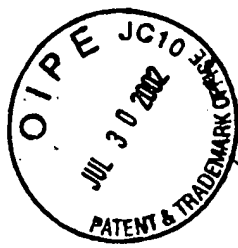


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FIG. 3

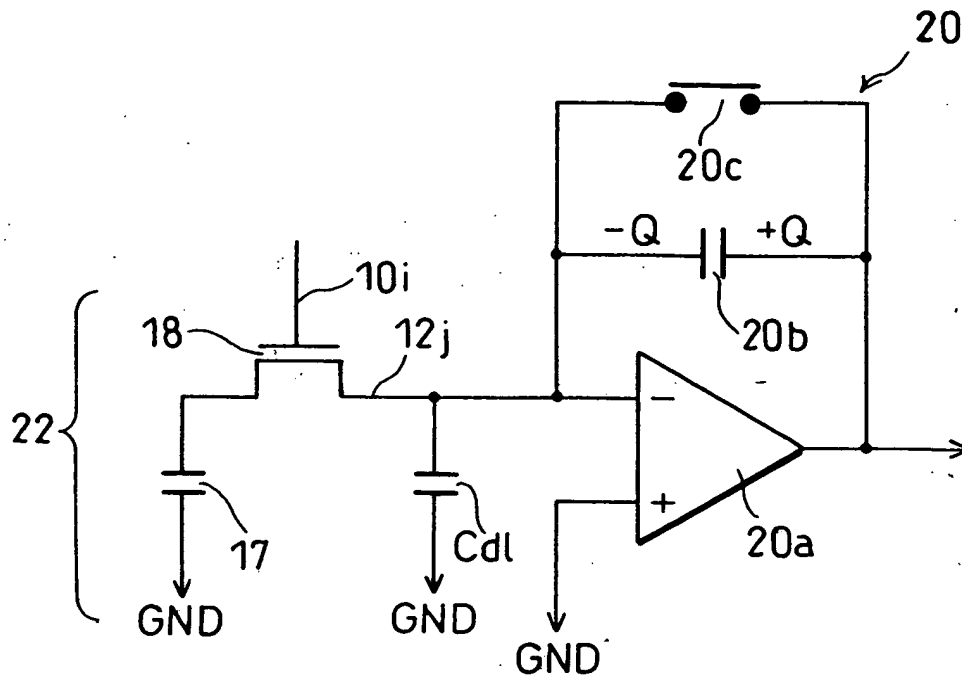


*Prior Art*

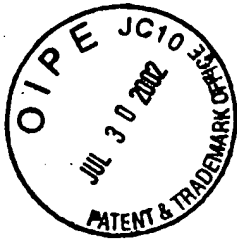


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FIG. 4

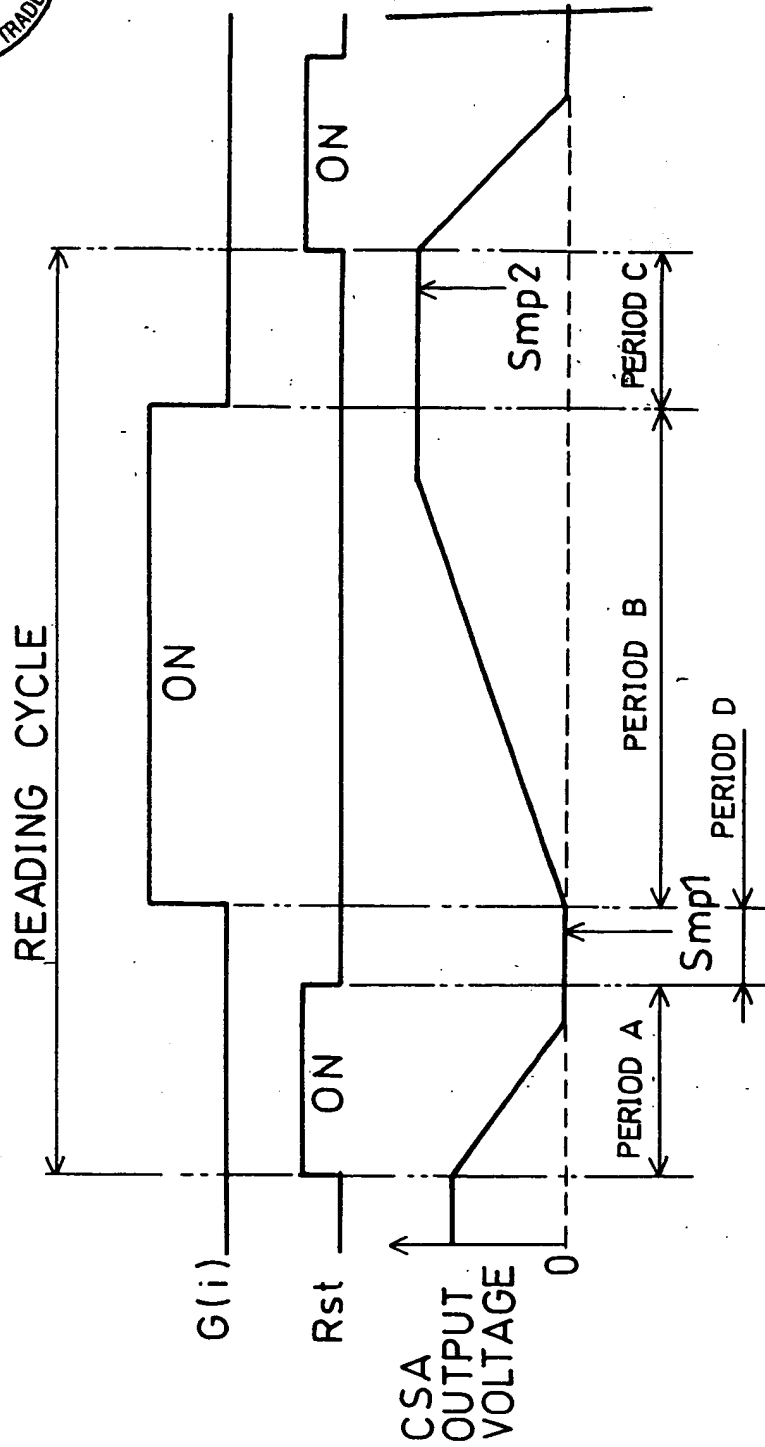


*Prior Art*

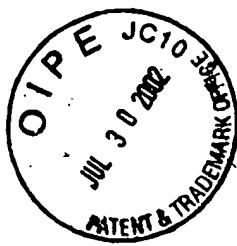


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FIG. 5

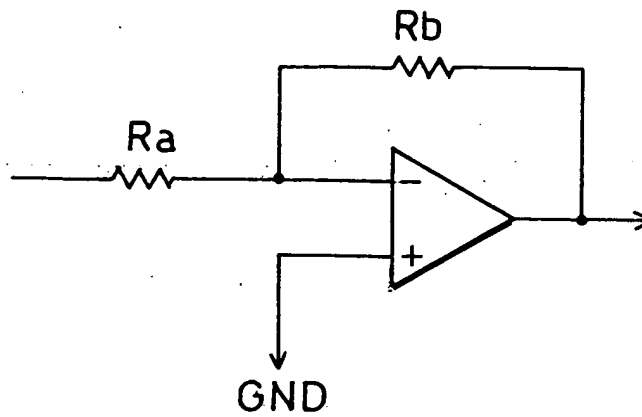


Prior Art

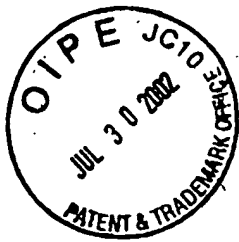


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FIG. 6

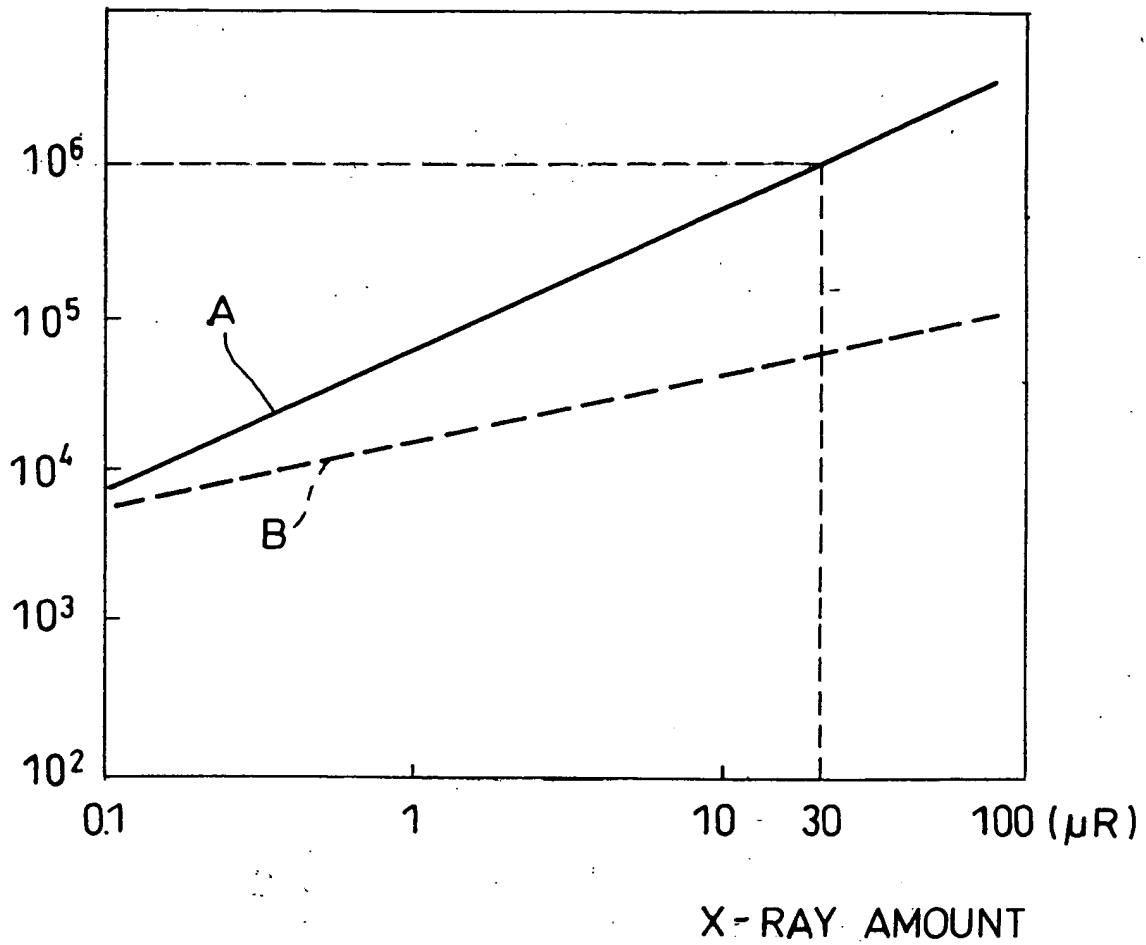


*Prior Art*



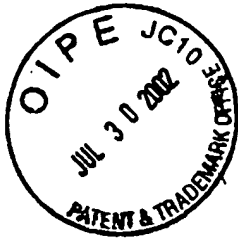
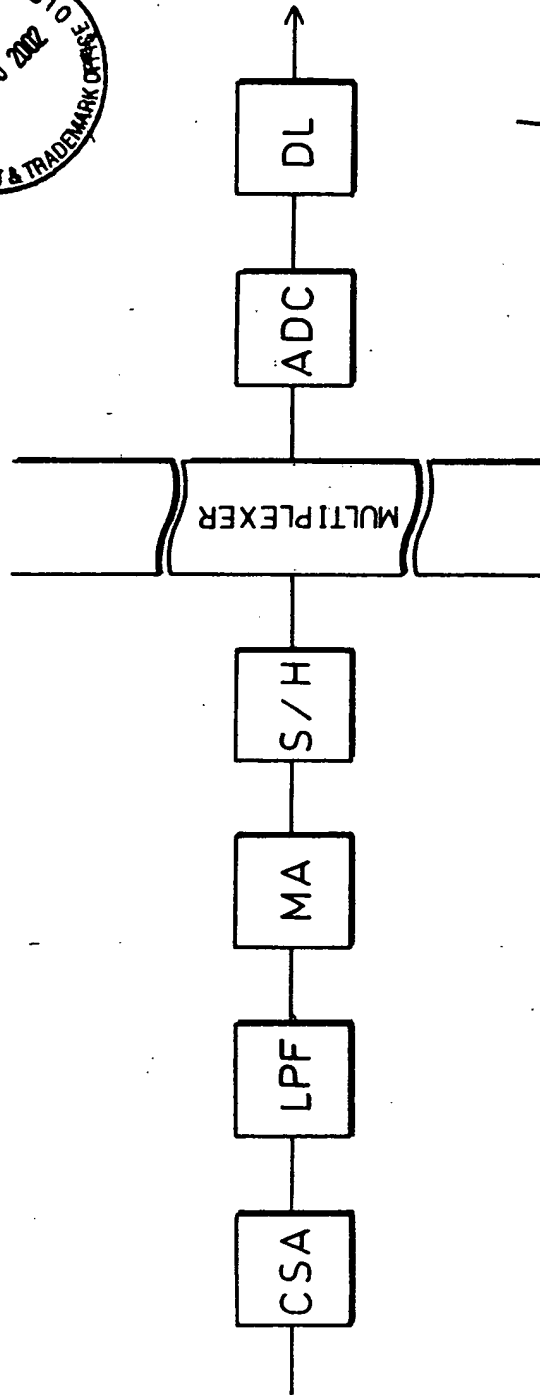
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FIG. 7



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FIG. 8



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*Prior Art*

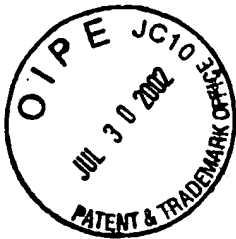
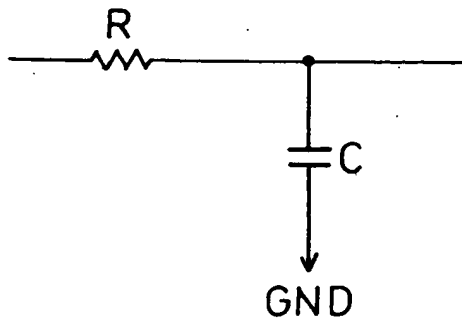


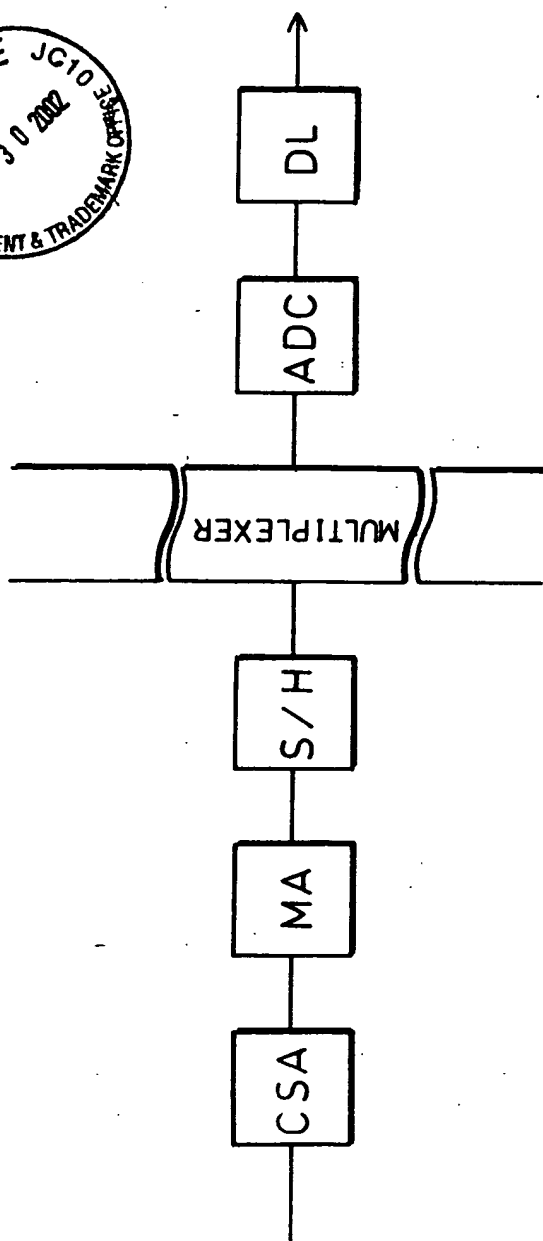
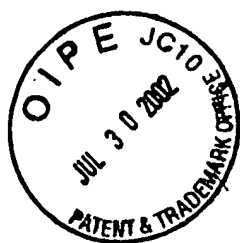
FIG. 9

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FIG. 13



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